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Form: PTO-1595

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DOCKET NUMBER: 50V8319.01

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

5.25.06

1. Name of conveying party(ies): Seiji Iseda Execution Date: 05/23/2006

Additional name(s) of conveying party(ies) attached? Yes No

2. 1. Name and address of receiving party(ies)

Name: Sony Corporation

Street Address: 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku

City: Tokyo Country: Japan

3 Name of conveyance:

Assignment Merger

Security Agreement Change of Name

Other

Execution Date: see above

2. Name and address of receiving party(ies)

Name: Sony Electronics Inc.

Street Address: 1 Sony Drive

City: Park Ridge State: NJ Zip: 07656

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is _____

A. Patent Application No.(s) _____ B. Patent No.(s) _____

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Stuart H. Mayer

Internal Address: Mayer & Williams, PC

Street Address: 251 North Avenue West, 2nd Floor

City: Westfield

State: New Jersey Zip: 07090

6. Total number of applications and patents involved:

7. Total fee (37 CFR 3.41) \$40.00

Credit Card - PTO-2038 enclosed

Authorized to be charged to deposit account

8. Deposit account number: _____

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9 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document

Marjorie Scariati
Name of Person Signing

Marjorie Scariati
Signature

5/25/06
Date

Total number of pages including cover sheet, attachments, and documents:

ASSIGNMENT

WHEREAS, I, as a below named inventor, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

METHOD AND APPARATUS FOR ETCHING A STRUCTURE IN A PLASMA CHAMBER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan and Sony Electronics Inc. a Delaware corporation with offices at 1 Sony Drive, Park Ridge, New Jersey 07656 (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

